

# P-Channel 40-V (D-S) MOSFET

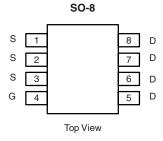
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
- 40	$0.014 \text{ at V}_{GS} = -10 \text{ V}$	- 10.5	40		
	0.021 at V <sub>GS</sub> = - 4.5 V	- 8.7	40		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

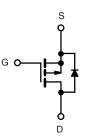






Ordering Information: Si4401BDY-T1-E3 (Lead (Pb)-free)

Si4401BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS TA	= 25 °C, unle	ss otherwise r	noted		
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 40		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current /T 150 °C\2	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 10.5	- 8.7	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		- 8.3	- 5.9	
Pulsed Drain Current		I <sub>DM</sub>	- 50		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	- 2.6	- 1.36		
Avalanche Current	L = 1 mH	I <sub>AS</sub>	3	30	
Single Pulse Avalanche Energy		E <sub>AS</sub>	45		mJ
Mariana Barra Biratian	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.9	1.5	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		1.85	0.95	VV
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana la Antique	t ≤ 10 s	R <sub>thJA</sub> -	36	43	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		70	84	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	16	21	

#### Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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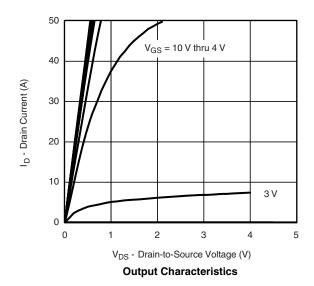
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Coto Valtono Duoin Comunit		V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V	- 1		- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 30			Α	
Durin Course On Obela Desirtance	В	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10.5 A		0.011	0.014	0	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 8.7 A		0.0165	0.021	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 10.5 A		26		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 2.7 A, V <sub>GS</sub> = 0 V		- 0.74	- 1.1	V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			40	55		
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 5 V, I <sub>D</sub> = - 10.5 A		10		nC	
Gate-Drain Charge	$Q_{gd}$			14			
Gate Resistance	$R_g$		1.4	2.8	4.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			16	25		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$		15	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 1 A, $V_{GEN} =$ - 10 V, $R_g = 6 \Omega$		97	150	ns	
Fall Time	t <sub>f</sub>			47	75		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 2.1 A, dI/dt = 100 A/μs		35	55		

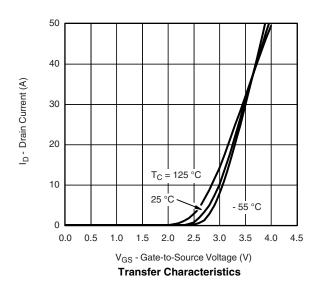
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

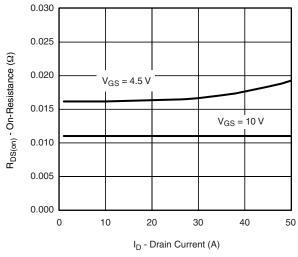
# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



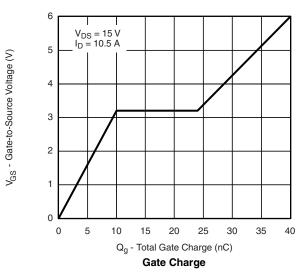


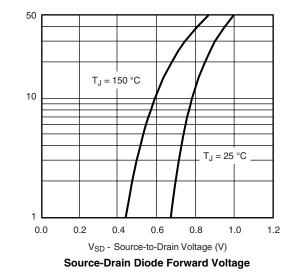


## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



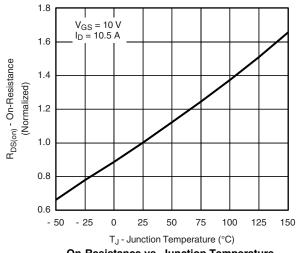
#### On-Resistance vs. Drain Current



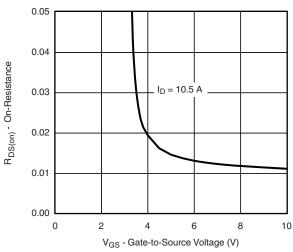


4500 4000 3500 C - Capacitance (pF) 3000 2500 2000 1500 Coss 1000 500 0 0 5 10 15 20 25 30 35 40 V<sub>DS</sub> - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature



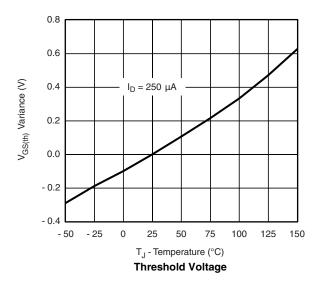
On-Resistance vs. Gate-to-Source Voltage

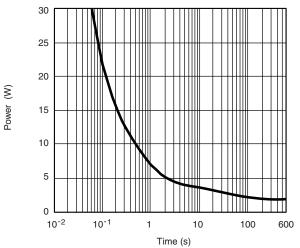
I<sub>S</sub> - Source Current (A)

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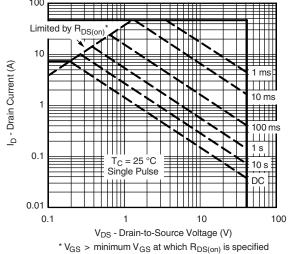
# VISHAY

# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

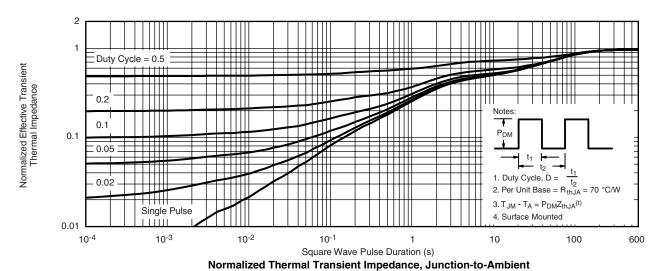




Single Pulse Power, Junction-to-Ambient

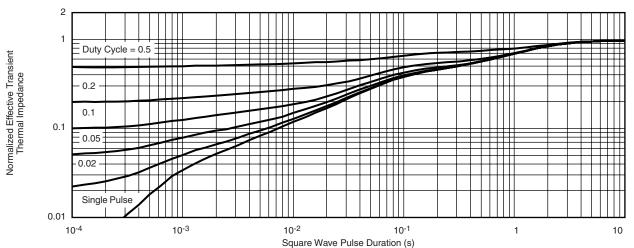


Safe Operating Area





## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



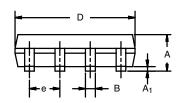
Normalized Thermal Transient Impedance, Junction-to-Foot

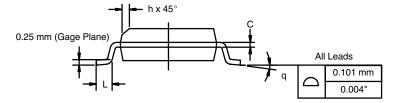
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**SOIC (NARROW): 8-LEAD** JEDEC Part Number: MS-012







	MILLIM	MILLIMETERS INCHES				
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
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## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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